

8-Bit Buffered Multiplying DAC

AD7524

FEATURES

Microprocessor Compatible (6800, 8085, Z80, Etc.)
TTL/CMOS Compatible Inputs
On-Chip Data Latches
Endpoint Linearity
Low Power Consumption
Monotonicity Guaranteed (Full Temperature Range)
Latch Free (No Protection Schottky Required)

APPLICATIONS

Microprocessor Controlled Gain Circuits Microprocessor Controlled Attenuator Circuits Microprocessor Controlled Function Generation Precision AGC Circuits Bus Structured Instruments

GENERAL DESCRIPTION

The AD 7524 is a low cost, 8-bit monolithic CMOSDAC designed for direct interface to most microprocessors.

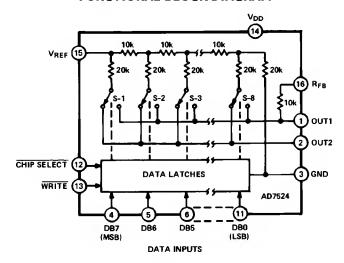
Basically an 8-bit DAC with input latches, the AD 7524's load cycle is similar to the "write" cycle of a random access memory. Using an advanced thin-film on CM OS fabrication process, the AD 7524 provides accuracy to 1/8 LSB with a typical power dissipation of less than 10 milliwatts.

A newly improved design eliminates the protection Schottky previously required and guarantees TTL compatibility when using a +5 V supply. Loading speed has been increased for compatibility with most microprocessors.

Featuring operation from +5 V to +15 V, the AD 7524 interfaces directly to most microprocessor buses or output ports.

Excellent multiplying characteristics (2- or 4-quadrant) make the AD 7524 an ideal choice for many microprocessor controlled gain setting and signal control applications.

FUNCTIONAL BLOCK DIAGRAM



ORDERING GUIDE

Model ¹	Temperature Range	Nonlinearity $(V_{DD} = +15 V)$	Package Option ²
AD 7524JN	-40°C to +85°C	±1/2 LSB	N-16
AD 7524K N	-40°C to +85°C	±1/4 LSB	N-16
AD 7524L N	-40°C to +85°C	±1/8 LSB	N-16
AD 7524JP	-40°C to +85°C	±1/2 LSB	P-20A
AD 7524K P	-40°C to +85°C	±1/4 LSB	P-20A
AD 7524LP	-40°C to +85°C	±1/8 L SB	P-20A
AD 7524JR	-40°C to +85°C	±1/2 LSB	R-16A
AD 7524AQ	-40°C to +85°C	±1/2 LSB	Q-16
AD 7524BQ	-40°C to +85°C	±1/4 LSB	Q-16
AD 7524C Q	-40°C to +85°C	±1/8 LSB	Q-16
AD 7524SQ	-55°C to +125°C	±1/2 LSB	Q-16
AD 7524T Q	-55°C to +125°C	±1/4 LSB	Q-16
AD 7524U Q	-55°C to +125°C	±1/8 LSB	Q-16
AD 7524SE	-55°C to +125°C	±1/2 LSB	E-20A
AD 7524T E	-55°C to +125°C	±1/4 LSB	E-20A
AD 7524U E	-55°C to +125°C	±1/8 LSB	E-20A

NOTES

¹To order MIL-STD-883, Class B processed parts, add/883B to part number. Contact your local sales office for military data sheet. For U.S. Standard Military Drawing (SMD) see DESC drawing #5962-87700.

 2 E = Leadless Ceramic Chip Carrier: N = Plastic DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = SOIC.

AD7524- SPECIFICATIONS (V_{REF} = +10 V, V_{OUT1} = V_{OUT2} = 0 V, unless otherwise noted)

Parameter	Limit, V _{DD} = +5 V	T _A = +25°C V _{DD} = +15 V	V _{DD} = 5 V	T_{MIN}, T_{MAX}^{1} $\mid V_{DD} = +15V$	Units	Test Conditions/Comments
STATIC PERFORMANCE	100	- 55		- 55		
Resolution	8	8	8	8	Bits	
R elative A ccuracy	"	0	١	"	Ditts	
I, A, S Versions	±1/2	±1/2	±1/2	±1/2	L SB max	
K, B, T Versions	±1/2	$\pm 1/4$	$\pm 1/2$	±1/4	LSB max	
L, C, U Versions	±1/2	±1/8	$\pm 1/2$	±1/4 ±1/8	L SB max	
					LSD IIIdX	
M onotonicity	Guaranteed		Guaranteed	Guaranteed	L CD	
Gain Error ²	±2 1/2	±1 1/4	±3 1/2	±1 1/2	L SB max	Cain TC Maraural form 1250C to
A verage Gain T C ³	±40	±10	±40	±10	ppm/°C	Gain T C M easured from +25°C to T _{MIN} or from +25°C to T _{MAX}
DC Supply Rejection, ³ ΔG ain/ΔV _{DD}	0.08 0.002	0.02 0.001	0.16 0.01	0.04 0.005	% FSR/% max % FSR/% typ	$\Delta V_{DD} = \pm 10\%$
Output Leakage Current						
I _{OUT1} (Pin 1)	±50	±50	±400	±200	nA max	DB0-DB7 = 0 V; \overline{WR} , \overline{CS} = 0 V; V_{REF} = ±10 V
I _{OUT 2} (Pin 2)	±50	±50	±400	±200	nA max	DB0-DB7 = V_{DD} ; \overline{WR} , \overline{CS} = 0 V; V_{REF} = ±10 V
DYNAMIC PERFORMANCE						- BBY Y Y REY
Output Current Settling Time ³	100	250	500	350		OUT 1 and 100 0 0 13 -5 -
(to 1/2 L SB)	400	250	500	350	ns max	OUT1Load = 100Ω , $C_{EXT} = 13 pF$; \overline{WR} , $\overline{CS} = 100 \Omega$
						0 V ; DB0-DB7 = 0 V to V_{DD} to 0 V .
AC Feedthrough ³						
at OUT 1	0.25	0.25	0.5	0.5	% FSR max	$V_{REF} = \pm 10 V$, 100 kH z Sine W ave; D B0-D B7
at OUT 2	0.25	0.25	0.5	0.5	% FSR max	$0 \text{ V}; \overline{\text{WR}}, \overline{\text{CS}} = 0 \text{ V}$
REFERENCE INPUT						
R _{IN} (Pin 15 to GND) ⁴	5	5	5	5	kΩ min	
KIN (FIII 13 to GND)	20	20	20	20	kΩ max	
	20	20	20	20	K75 IIIdX	
ANALOG OUTPUTS						
Output Capacitance ³						
Ċ _{OU⊤1} (Pin 1)	120	120	120	120	pF max	DB0-DB7 = V_{DD} ; \overline{WR} , \overline{CS} = 0 V
C _{OUT2} (Pin 2)	30	30	30	30	pF max	
C _{OUT1} (Pin 1)	30	30	30	30	pF max	DB0-DB7 = 0 V; \overline{WR} , \overline{CS} = 0 V
C _{OUT2} (Pin 2)	120	120	120	120	pF max	DB0 DB7 = 0 V, WIQ CB = 0 V
	120	120	120	120	pr max	
DIGITAL INPUTS						
Input HIGH Voltage Requirement						
V _{IH}	+2.4	+13.5	+2.4	+13.5	V min	
Input LOW Voltage Requirement						
V _{IL}	+0.8	+1.5	+0.5	+1.5	V max	
Input Current				12.5		
I _{IN}	±1	±1	±10	±10	μA max	$V_{IN} = 0 \text{ V or } V_{DD}$
Input Capacitance ³	- -	- •	-10	-10	μΛ max	VIN = 0 V OI V DD
DB0-DB7	5	5	-	-	pF max	V _{IN} = 0 V
			5	5		V _{IN} = 0 V
WR, CS	20	20	20	20	pF max	V _{IN} = 0 V
SWITCHING CHARACTERISTICS						
Chip Select to Write Setup Time ⁵						See Timing Diagram
t _{cs}						$t_{WR} = t_{CS}$
ÃĎ 7524J, K, L, A, B, C	170	100	220	130	ns min	
AD 7524S, T, U	170	100	240	150	ns min	
C hip Select to Write Hold Time		-00	0	-50		
t _{CH}						
All Grades	0	0	0	0	ns min	
Write Pulse Width	١٠	١٠	ال	١٠	113 111111	
						1
t _{WR}	170	100	220	170		$t_{CS} \ge t_{WR}, t_{CH} \ge 0$
AD 7524J, K, L, A, B, C	170	100	220	130	ns min	
AD 7524S, T, U	170	100	240	150	ns min	
D ata Setup T ime						
t _{DS}						
AD 7524J, K, L, A, B, C	135	60	170	80	ns min	
AD 7524S, T, U	135	60	170	100	ns min	
D ata H old Time	1 2		1			
t _{DH}						
All Grades	10	10	10	10	ns min	
	10	10	10	10	113111111	
POWER SUPPLY			1_	_	l .	
DD	1	2	2	2	mA max	All Digital Inputs V _{IL} or V _{IH}
	100	100	500	500	μA max	All Digital Inputs 0 V or V _{DD}

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NOTES

To emperature ranges as follows: J, K, L versions: -40°C to +85°C

A, B, C versions: -40°C to +85°C

S, T, U versions: -55°C to +125°C

Gain error is measured using internal feedback resistor. Full-Scale Range (FSR) = V_{REF}.

Guaranteed not tested.

DAC thin-film resistor temperature coefficient is approximately -300 ppm/°C.

AC parameter, sample tested @ +25°C to ensure conformance to specification.

Specifications subject to change without notice.

Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*

 $(T_A = +25$ °C, unless otherwise noted)

/ _{DD} to GND0.3 V, +17 V	/
/ _{RFB} to GND±25 \	
/ _{REF} to G N D	V
Digital Input Voltage to GND $\dots -0.3$ V to V_{DD} +0.3 V	V
$OUT1$, $OUT2$ to GND 0.3 V to V_{DD} +0.3 V	V

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Power Dissipation (Any Package)
T o +75°C
D erates above 75°C by 6 mW/°C
Operating Temperature
Commercial (J, K, L)40°C to +85°C
Industrial (A, B, C)40°C to +85°C
Extended (S, T, U)55°C to +125°C
Storage T emperature65°C to +150°C
Lead Temperature (Soldering, 10 secs) +300°C

CAUTION.

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD 7524 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



TERMINOLOGY

RELATIVE ACCURACY: A measure of the deviation from a straight line through the end points of the DAC transfer function. Normally expressed as a percentage of full scale range. For the AD 7524 DAC, this holds true over the entire V_{RFF} range.

RESOLUTION: Value of the LSB. For example, a unipolar converter with n bits has a resolution of (2^{-n}) (V_{REF}). A bipolar converter of n bits has a resolution of $[2^{-(n-1)}]$ [V_{REF}]. Resolution in no way implies linearity.

GAIN ERROR: Gain Error is a measure of the output error between an ideal DAC and the actual device output. It is measured

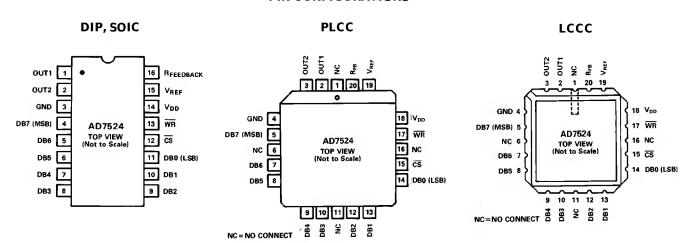
with all 1s in the DAC after offset error has been adjusted out and is expressed in LSBs. Gain Error is adjustable to zero with an external potentiometer.

FEEDTHROUGH ERROR: Error caused by capacitive coupling from V_{REF} to output with all switches OFF.

OUTPUT CAPACITANCE: C apacity from OUT1 and OUT2 terminals to ground.

OUTPUT LEAKAGE CURRENT: Current which appears on OUT1 terminal with all digital inputs LOW or on OUT2 terminal when all inputs are HIGH. This is an error current which contributes an offset voltage at the amplifier output.

PIN CONFIGURATIONS



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AD7524

CIRCUIT DESCRIPTION CIRCUIT INFORMATION

The AD 7524, an 8-bit multiplying D/A converter, consists of a highly stable thin film R-2R ladder and eight N-channel current switches on a monolithic chip. M ost applications require the addition of only an output operational amplifier and a voltage or current reference.

The simplified D/A circuit is shown in Figure 1. An inverted R-2R ladder structure is used—that is, the binarily weighted currents are switched between the OUT1 and OUT2 bus lines, thus maintaining a constant current in each ladder leg independent of the switch state.

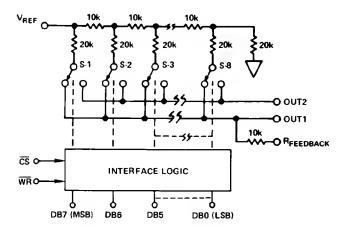


Figure 1. Functional Diagram

EOUIVALENT CIRCUIT ANALYSIS

The equivalent circuit for all digital inputs LOW is shown in Figures 2. In Figure 2 with all digital inputs LOW, the reference current is switched to OUT 2. The current source ILEAKAGE is composed of surface and junction leakages to the substrate

while the $\frac{1}{256}$ current source represents a constant 1-bit cur-

rent drain through the termination resistor on the R-2R ladder. The "ON" capacitance of the output N-channel switches is 120 pF, as shown on the OUT2 terminal. The "OFF" switch capacitance is 30 pF, as shown on the OUT1 terminal. Analysis of the circuit for all digital inputs high is similar to Figure 2 however, the "ON" switches are now on terminal OUT 1, hence the 120 pF appears at that terminal.

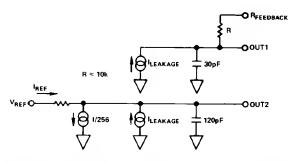


Figure 2. AD7524 DAC Equivalent Circuit—All Digital Inputs Low

INTERFACE LOGIC INFORMATION **MODE SELECTION**

AD 7524 mode selection is controlled by the $\overline{\text{CS}}$ and $\overline{\text{WR}}$ inputs.

WRITE MODE

When $\overline{\text{CS}}$ and $\overline{\text{WR}}$ are both LOW, the AD 7524 is in the WRITE mode, and the AD 7524 analog output responds to data activity at the DB0-DB7 data bus inputs. In this mode, the AD 7524 acts like a nonlatched input D/A converter.

HOLD MODE

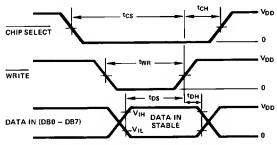
When either \overline{CS} or \overline{WR} is HIGH, the AD 7524 is in the HOLD mode. The AD 7524 analog output holds the value corresponding to the last digital input present at DB0-DB7 prior to \overline{WR} or CS assuming the HIGH state.

MODE SELECTION TABLE

CS	WR	Mode	DAC Response
L	L	Write	DAC responds to data bus (DB0-DB7) inputs.
Н	Х	H old	D ata bus (DB0-DB7) is Locked Out:
Χ	Н	H old	DAC holds last data present when \overline{WR} or \overline{CS} assumed HIGH state.

L = Low State, H = High State, X = Don't Care.

WRITE CYCLE TIMING DIAGRAM



- NOTES:

 1. All input signal rise end fall times measured from 10% to 90% of V_{DD} . V_{DD} = +5V, t_r = t_f = 20ns; V_{DD} = +15V, t_r = t_f = 40ns.
- 2. Timing Measurement Reference level is
- 3. tps + tph is approximately constant et 145ns mir et +25°C, Vpp = +5V and t_{wr} = 170ns min. The AD7524 is specified for a minimum tph of 10ns, however, in applications where tph > 10ns, tps may be reduced accordingly up to the limit tps = 65ns, tpH = 80ns.

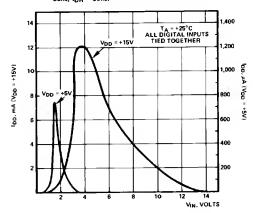


Figure 3. Supply Current vs. Logic Level Typical plots of supply current, I_{DD}, versus logic input voltage, V_{IN} , for $V_{DD} = +5 \text{ V}$ and $V_{DD} = +15 \text{ V}$ are shown above.

ANALOG CIRCUIT CONNECTIONS

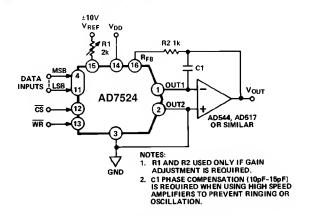


Figure 4. Unipolar Binary Operation (2-Quadrant Multiplication)

Table I. Unipolar Binary Code Table

Digital Input MSB LSB	Analog Output
1111 1111	-V _{REF} (255/256)
1000 0001	-V _{REF} (129/256)
1000 0000	-V _{REF} (128/256) = -V _{REF} /2
0111 1111	-V _{REF} (127/256)
0000 0001	$-V_{REF}$ (1/256)
0000 0000	$-V_{REF}$ (0/256) = 0

Note: $1 LSB = (2^{-8})(V_{REF}) = 1/256 (V_{REF})$

MICROPROCESSOR INTERFACE

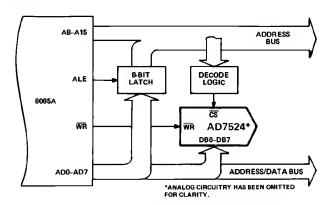


Figure 6. AD7524/8085A Interface

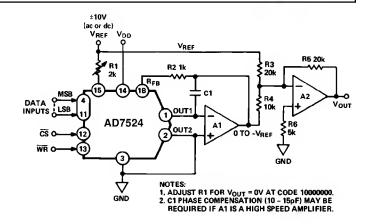


Figure 5. Bipolar (4-Quadrant) Operation

Table II. Bipolar (Offset Binary) Code Table

Digital Input MSB LSB	Analog Output +V _{RFF} (127/128)	
1111 1111		
1000 0001	+V _{RFF} (1/128)	
1000 0000	0	
0111 1111	-V _{RFF} (1/128)	
0000 0001	-V _{REF} (127/128)	
0000 0000	-V _{REF} (128/128)	
	11L1 1 1	

Note: $1 LSB = (2^{-7})(V_{REF}) = 1/128 (V_{REF})$

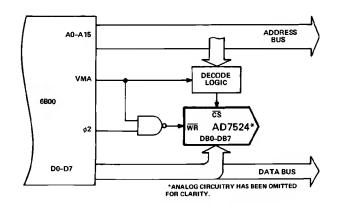


Figure 7. AD7524/MC6800 Interface

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POWER GENERATION

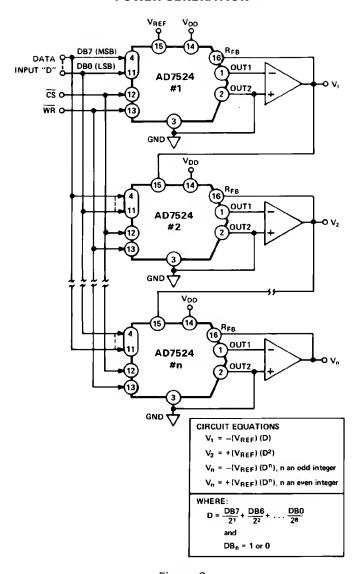


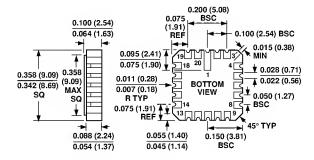
Figure 8.

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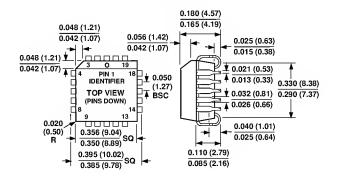
OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

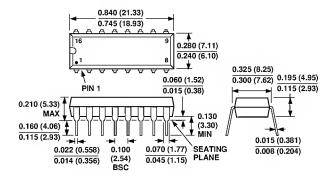
20-Terminal Ceramic Leadless Chip Carrier (E-20A)



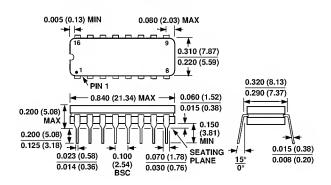
20-Lead Plastic Leadless Chip Carrier (PLCC) (P-20A)



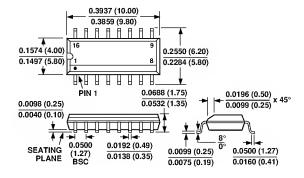
16-Lead Plastic DIP (Narrow) (N-16)



16-Lead Cerdip (Q-16)



16-Lead Narrow-Body (SOIC) (R-16A)



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